



### Important Dates

|                      |                            |
|----------------------|----------------------------|
| 15 February 2017     | Full paper submission      |
| 15 March 2017        | Notification of acceptance |
| 30 March 2017        | Early bird registration    |
| 15 April 2017        | Final submission           |
| 30 April 2017        | Normal registration        |
| 28-29 September 2017 | Conference Presentation    |

### Conference fees

|                         |                   |
|-------------------------|-------------------|
| Early bird registration | 1400PLN/350 Euro  |
| Normal registration     | 1800 PLN/450 Euro |



### Conference location

The First International Conference on Intelligent Systems in Production and Maintenance ISPM 2017 will be held in Wrocław (Poland) at the Wrocław University of Science and Technology.

Wrocław is the largest city in the south—western Poland and the capital of Dolnośląskie Voivodeship.



### Contact

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## ***International Conference on Intelligent Systems in Production and Maintenance***

### ***ISPEM'2017***

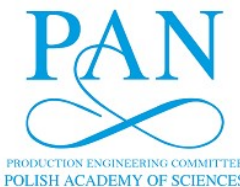
### ***September 28-29, 2017***

### ***Wrocław, Poland***

**[www.ispem2017.pwr.edu.pl](http://www.ispem2017.pwr.edu.pl)**



Wrocław University  
of Science and Technology



## About ISPEM'2017 conference

The First International Conference on Intelligent Systems in Production Engineering and Maintenance ISPEM 2017 will be held in Wrocław (Poland). The conference aim is to give an opportunity for researchers, experts, practitioners and other interested participants to exchange experiences in intelligent systems and tools applications in production and maintenance. New solutions for innovative plants, research results and case studies considering advances in maintenance and production from the Industry 4.0 point of view will be presented and discussed, paying special attention to application of intelligent systems, methods and tools in production, maintenance, logistic, quality management, information systems, product development, ect.

## Organizer

Wrocław University of Science and Technology  
and

Committee of Production Engineering  
of the Polish Academy of Sciences

### *General Chair of the Conference*

Edward Chlebus,

Wrocław University of Science and Technology

### *Co-chairs*

Anna Burduk,

Wrocław University of Science and Technology

Dariusz Mazurkiewicz,

Lublin University of Technology

## Topics:

### *Intelligent Systems applications in the following areas:*

- ◆ Production Systems Management and Maintenance
- ◆ Predictive Maintenance
- ◆ Modelling, Simulation and Design
- ◆ Production Planning and Scheduling
- ◆ Maintenance Planning and Scheduling
- ◆ Project Management
- ◆ Quality Management
- ◆ Production System Organization
- ◆ Lean Production
- ◆ Integration of Organizational and Technical Production Preparation
- ◆ Data Recognition
- ◆ Supply Chain Management
- ◆ Reliability & Risk Assessment
- ◆ Knowledge Discovery and Data Mining
- ◆ Green Production
- ◆ Software Tools for Production and Maintenance
- ◆ Control and Supervision
- ◆ Knowledge management and Decision Support Systems in Production
- ◆ E-maintenance and Mobile Technologies
- ◆ Manufacturing Methods and Tools
- ◆ Measuring Systems and Sensors



## Conference proceedings

The working language of ISPM'2017 is English. The material submitted must be original, not published or being considered elsewhere.

Conference proceedings will be published by Springer-Verlag in the series titled **Advances in Intelligent Systems and Computing**. The books of this series are submitted to ISI Proceedings (Web of Science), EI-Compendex, DBLP, SCOPUS, Google Scholar and Springerlink.

